# **ANALOG DEVICES**

# CMOS Low Voltage 4 $\Omega$ , 4-Channel Multiplexer

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S3

S4

S2 (9

FUNCTIONAL BLOCK DIAGRAM

1 OF 4 DECODER

A0 A1 FN

ADG704

8) D

# **ADG704**

#### FEATURES

+1.8 V to +5.5 V Single Supply 2.5  $\Omega$  (Typ) On Resistance Low On-Resistance Flatness -3 dB Bandwidth >200 MHz Rail-to-Rail Operation 10-Lead  $\mu$ SOIC Package Fast Switching Times  $t_{ON}$  20 ns  $t_{OFF}$  13 ns

Typical Power Consumption (<0.01 μW) TTL/CMOS Compatible

#### APPLICATIONS Battery Powered Systems Communication Systems

Sample-and-Hold Systems Audio Signal Routing Data Acquisition System Video Switching

#### **GENERAL DESCRIPTION**

The ADG704 is a CMOS analog multiplexer, comprising four single channels. This multiplexer is designed on an advanced submicron process that provides low power dissipation yet gives high switching speed, low on resistance, low leakage currents and high bandwidths.

The on resistance profile is very flat over the full analog signal range. This ensures excellent linearity and low distortion when switching audio signals. Fast switching speed also makes the part suitable for video signal switching.

The ADG704 can operate from a single supply range of +1.8 V to +5.5 V, making it ideal for use in battery powered instruments and with the new generation of DACs and ADCs from Analog Devices.

The ADG704 switches one of four inputs to a common output, D, as determined by the 3-bit binary address lines, A0, A1 and EN. A Logic "0" on the EN pin disables the device.

Each switch of the ADG704 conducts equally well in both directions when ON. The ADG704 exhibits break-before-make switching action.

The ADG704 is available in 10-lead µSOIC package.

#### **PRODUCT HIGHLIGHTS**

- +1.8 V to +5.5 V Single Supply Operation. The ADG704 offers high performance and is fully specified and guaranteed with +3 V and +5 V supply rails.
- 2. Very Low  $R_{ON}$  (4.5  $\Omega$  Max at 5 V, 8  $\Omega$  Max at 3 V). At supply voltage of +1.8 V,  $R_{ON}$  is typically 35  $\Omega$  over the temperature range.
- 3. Low On-Resistance Flatness.
- 4. -3 dB Bandwidth Greater than 200 MHz.
- Low Power Dissipation. CMOS construction ensures low power dissipation.
- 6. Fast  $t_{ON}/t_{OFF}$ .
- 7. Break-Before-Make Switching Action.
- 8. 10-Lead µSOIC Package.

#### REV. A

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# **ADG704**—**SPECIFICATIONS**<sup>1</sup> ( $V_{DD} = +5 V \pm 10\%$ , GND = 0 V. All Specifications -40°C to +85°C, unless otherwise noted.)

	<b>B</b> Version			
Parameter	+25°C	-40°C to +85°C	Units	Test Conditions/Comments
ANALOG SWITCH				
Analog Signal Range		0 V to $V_{DD}$	V	
On-Resistance (R <sub>ON</sub> )	2.5	0 V to VDD	Ωtyp	$V_{S} = 0 V \text{ to } V_{DD}, I_{DS} = -10 \text{ mA};$
On-Resistance (R <sub>0N</sub> )	4	4.5	•••	Test Circuit 1 $V_{DD}$ ,
On Desistance Match Dataset	4	4.5	Ω max	Test Circuit I
On-Resistance Match Between		0.1		
Channels ( $\Delta R_{ON}$ )		0.1	Ωtyp	$V_{\rm S}$ = 0 V to $V_{\rm DD}$ , $I_{\rm DS}$ = -10 mA
		0.4	$\Omega$ max	
On-Resistance Flatness $(R_{FLAT(ON)})$	0.75		Ωtyp	$V_{\rm S}$ = 0 V to $V_{\rm DD}$ , $I_{\rm DS}$ = -10 mA
		1.2	$\Omega$ max	
LEAKAGE CURRENTS				$V_{DD} = +5.5 V$
Source OFF Leakage I <sub>S</sub> (OFF)	±0.01		nA typ	$V_{\rm DD} = 19.5$ V $V_{\rm S} = 4.5$ V/1 V, $V_{\rm D} = 1$ V/4.5 V;
	$\pm 0.01$ $\pm 0.1$	±0.3	nA max	Test Circuit 2
Drain OFF Leakage I <sub>D</sub> (OFF)	$\pm 0.1$ $\pm 0.01$	÷0.5	nA typ	$V_{\rm S} = 4.5 \text{ V/1 V}, V_{\rm D} = 1 \text{ V/4.5 V};$
Dram Orr Leakage ID (Orr)	$\pm 0.01$ $\pm 0.1$	±0.3	nA max	$v_{\rm S} = 4.5 v/1 v, v_{\rm D} = 1 v/4.5 v,$ Test Circuit 2
Channel ON Leabase L. L. (ON)		10.5		
Channel ON Leakage $I_D$ , $I_S$ (ON)	$\pm 0.01$	$\pm 0.2$	nA typ	$V_S = V_D = 4.5 V \text{ or } 1 V;$ Test Circuit 3
	±0.1	±0.3	nA max	Test Circuit 5
DIGITAL INPUTS				
Input High Voltage, V <sub>INH</sub>		2.4	V min	
Input Low Voltage, V <sub>INL</sub>		0.8	V max	
Input Current				
I <sub>INL</sub> or I <sub>INH</sub>	0.005		μA typ	$V_{IN} = V_{INI}$ or $V_{INH}$
TIME OF TIME	0.005	$\pm 0.1$	µA max	TIN TINE OF TINH
		_ 0.1	put mun	
DYNAMIC CHARACTERISTICS <sup>2</sup>				
t <sub>ON</sub>	14		ns typ	$R_L = 300 \Omega, C_L = 35 pF$
		20	ns max	$V_{\rm S}$ = 3 V, Test Circuit 4
t <sub>OFF</sub>	6		ns typ	$R_L = 300 \Omega, C_L = 35 pF$
		13	ns max	$V_{\rm S}$ = 3 V, Test Circuit 4
Break-Before-Make Time Delay, t <sub>D</sub>	8		ns typ	$R_{L} = 300 \Omega, C_{L} = 35 pF$
		1	ns min	$V_{S1} = V_{S2} = 3 V$ , Test Circuit 5
Charge Injection	3		pC typ	$V_{\rm S} = 2 V, R_{\rm S} = 0 \Omega, C_{\rm L} = 1 \text{ nF};$
σ,				Test Circuit 6
Off Isolation	-60		dB typ	$R_L = 50 \Omega, C_L = 5 pF, f = 10 MHz$
	-80		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ;
				Test Circuit 7
Channel-to-Channel Crosstalk	-62		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 10 MHz$
Granner to Granner Grosstaik	-82		dB typ dB typ	$R_L = 50 \Omega_2, C_L = 5 \text{ pF}, f = 1 \text{ MHz};$ $R_L = 50 \Omega, C_L = 5 \text{ pF}, f = 1 \text{ MHz};$
	-02			Test Circuit 8
Bandwidth –3 dB	200		MHz typ	$R_{\rm L} = 50 \ \Omega, C_{\rm L} = 5 \ pF;$ Test Circuit 9
				$n_L = 50.22$ , $C_L = 5$ pr; 1 est Circuit
$C_{\rm S}$ (OFF)	9		pF typ	
$C_{\rm D}$ (OFF)	37		pF typ	
$C_D, C_S(ON)$	54		pF typ	
POWER REQUIREMENTS				$V_{DD} = +5.5 V$
-				Digital Inputs = $0 \text{ V or } 5 \text{ V}$
	0.001		μA typ	
I <sub>DD</sub>	0.001			

NOTES <sup>1</sup>Temperature ranges are as follows: B Version: -40°C to +85°C.

<sup>2</sup>Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

# **SPECIFICATIONS**<sup>1</sup> ( $V_{DD} = +3 V \pm 10\%$ , GND = 0 V. All Specifications -40°C to +85°C, unless otherwise noted.)

	B Version -40°C to			
Parameter	+25°C	+85°C	Units	Test Conditions/Comments
ANALOG SWITCH				
Analog Signal Range		$0 \text{ V}$ to $V_{DD}$	V	
On-Resistance (R <sub>ON</sub> )	4.5	5	$\Omega$ typ	$V_{S} = 0 V$ to $V_{DD}$ , $I_{DS} = -10 mA$ ;
		8	$\Omega$ max	Test Circuit 1
On-Resistance Match Between				
Channels ( $\Delta R_{ON}$ )	0.1		$\Omega$ typ	$V_{S} = 0 V$ to $V_{DD}$ , $I_{DS} = -10 mA$
		0.4	$\Omega$ max	
On-Resistance Flatness (R <sub>FLAT(ON)</sub> )		2.5	Ω typ	$V_{S} = 0 V$ to $V_{DD}$ , $I_{DS} = -10 mA$
LEAKAGE CURRENTS				$V_{DD} = +3.3 \text{ V}$
Source OFF Leakage I <sub>S</sub> (OFF)	±0.01		n A trin	$V_{DD} = +3.5 V$ $V_{S} = 3 V/1 V, V_{D} = 1 V/3 V;$
Source OFF Leakage I <sub>S</sub> (OFF)	$\pm 0.01$ $\pm 0.1$	±0.3	nA typ nA max	Test Circuit 2
Drain OFF Lookage L (OFF)		±0.5		
Drain OFF Leakage $I_D$ (OFF)	$\pm 0.01$	$\pm 0.2$	nA typ	$V_{\rm S} = 3 \text{ V/1 V}, V_{\rm D} = 1 \text{ V/3 V};$
	$\pm 0.1$	±0.3	nA max	Test Circuit 2
Channel ON Leakage I <sub>D</sub> , I <sub>S</sub> (ON)	$\pm 0.01$	10.2	nA typ	$V_{\rm S} = V_{\rm D} = 3 \text{ V or } 1 \text{ V};$
	±0.1	±0.3	nA max	Test Circuit 3
DIGITAL INPUTS				
Input High Voltage, V <sub>INH</sub>		2.0	V min	
Input Low Voltage, V <sub>INL</sub>		0.4	V max	
Input Current				
I <sub>INL</sub> or I <sub>INH</sub>	0.005		μA typ	$V_{IN} = V_{INL}$ or $V_{INH}$
		$\pm 0.1$	µA max	
DYNAMIC CHARACTERISTICS <sup>2</sup>				
	16		ns tun	$R_{L} = 300 \Omega, C_{L} = 35 pF$
t <sub>ON</sub>	10	24	ns typ ns max	$V_{\rm S} = 2$ V, Test Circuit 4
*	0	24		$R_{\rm L} = 300 \ \Omega, \ C_{\rm L} = 35 \ pF$
t <sub>OFF</sub>	8	16	ns typ	
Durch Defens Males Time Deles t	0	16	ns max	$V_s = 2 V$ , Test Circuit 4
Break-Before-Make Time Delay, $t_D$	9	1	ns typ	$R_{L} = 300 \Omega, C_{L} = 35 pF$
		1	ns min	$V_{S1} = V_{S2} = 2 V$ , Test Circuit 5
Charge Injection	3		pC typ	$V_{\rm S} = 1.5 \text{ V}, \text{ R}_{\rm S} = 0 \Omega, \text{ C}_{\rm L} = 1 \text{ nF};$
Off Is slation	()		ID to	Test Circuit 6 $P_{1} = 500$ C $= 5 \text{ s} \text{ F}$ f = 10 MHz
Off Isolation	-60		dB typ	$R_L = 50 \Omega, C_L = 5 pF, f = 10 MHz$
	-80		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ;
	(2)		ID to	Test Circuit 7 $P_{1} = 500$ C = 5 $r_{1} = 10$ MHz
Channel-to-Channel Crosstalk	-62		dB typ	$R_L = 50 \Omega, C_L = 5 pF, f = 10 MHz$
	-82		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ;
Development data 2 dD	202		MTT_ ·	Test Circuit 8
Bandwidth –3 dB	200		MHz typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ ; Test Circuit 9
C <sub>s</sub> (OFF)	9		pF typ	
C <sub>D</sub> (OFF)	37		pF typ	
$C_D, C_S(ON)$	54		pF typ	
POWER REQUIREMENTS				$V_{DD} = +3.3 V$
-				Digital Inputs = $0 \text{ V or } 3 \text{ V}$
I <sub>DD</sub>	0.001		μA typ	
	1	1.0	µA max	

NOTES <sup>1</sup>Temperature ranges are as follows: B Version: -40°C to +85°C.

<sup>2</sup>Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

# ADG704

#### ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

 $(T_A = +25^{\circ}C \text{ unless otherwise noted})$ 

$V_{\text{DD}}$ to GND $\ldots \ldots \ldots$
Analog, Digital Inputs <sup>2</sup> $-0.3$ V to V <sub>DD</sub> +0.3 V or
30 mA, Whichever Occurs First
Continuous Current, S or D 30 mA
Peak Current, S or D 100 mA
(Pulsed at 1 ms, 10% Duty Cycle Max)
Operating Temperature Range
Industrial (B Version)40°C to +85°C
Storage Temperature Range65°C to +150°C
Junction Temperature
µSOIC Package, Power Dissipation
$\theta_{JA}$ Thermal Impedance
Lead Temperature, Soldering
Vapor Phase (60 sec) +215°C
Infrared (15 sec) +220°C
ESD

NOTES

<sup>1</sup>Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.

<sup>2</sup>Overvoltages at IN, S or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

#### **ORDERING GUIDE**

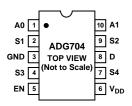
Model	Temperature Range	Brand <sup>1</sup>	Package Option <sup>2</sup>
ADG704BRM	$-40^{\circ}$ C to $+85^{\circ}$ C	S9B	RM-10

NOTES

 $^{1}$ Brand = Due to small package size, these three characters represent the part number.

 $^{2}$ RM =  $\mu$ SOIC.

#### PIN CONFIGURATION (10-Lead µSOIC)



#### TERMINOLOGY

TERMINOLOU	
V <sub>DD</sub>	Most positive power supply potential.
GND	Ground (0 V) reference.
S	Source terminal. May be an input or output.
D	Drain terminal. May be an input or output.
A0, A1	Logic control inputs.
EN	Logic control input.
R <sub>ON</sub>	Ohmic resistance between D and S.
$\Delta R_{ON}$	On resistance match between any two chan-
011	nels i.e., R <sub>ON</sub> max–R <sub>ON</sub> min.
R <sub>FLAT(ON)</sub>	Flatness is defined as the difference between the maximum and minimum value of on resis- tance as measured over the specified analog signal range.
I <sub>D</sub> (OFF)	Drain leakage current with the switch "OFF."
I <sub>S</sub> (OFF)	Source leakage current with the switch "OFF."
$I_D, I_S (ON)$	Channel leakage current with the switch "ON."
$V_D(V_S)$	Analog voltage on terminals D, S.
C <sub>S</sub> (OFF)	"OFF" switch source capacitance.
C <sub>D</sub> (OFF)	"OFF" switch drain capacitance.
$C_D, C_S (ON)$	"ON" switch capacitance.
t <sub>ON</sub>	Delay between applying the digital control input and the output switching on. See Test Circuit 4.
t <sub>OFF</sub>	Delay between applying the digital control input and the output switching off.
t <sub>D</sub>	"OFF" time or "ON" time measured between the 90% points of both switches, when switching from one address state to another. See Test Circuit 5.
Crosstalk	A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.
Off Isolation	A measure of unwanted signal coupling through an "OFF" switch.
Charge	A measure of the glitch impulse transferred
Injection	from the digital input to the analog output during switching.
Bandwidth	The frequency at which the output is attenuated by $-3$ dBs.
On Response	The frequency response of the "ON" switch.
On Loss	The voltage drop across the "ON" switch, seen on the On Response vs. Frequency plot as how many dBs the signal is away from 0 dB at very low frequencies.

#### Table I. Truth Table

A1	A0	EN	ON Switch
X	X	0	NONE
0	0	1	1
0	1	1	2
1	0	1	3
1	1	1	4

#### CAUTION -

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG704 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



### **Typical Performance Characteristics-ADG704**

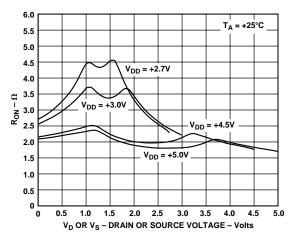


Figure 1. On Resistance as a Function of  $V_{\text{D}}\left(V_{\text{S}}\right)$  Single Supplies

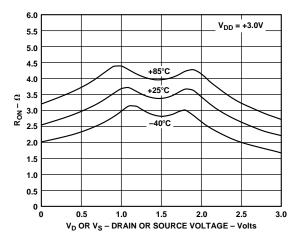


Figure 2. On Resistance as a Function of  $V_D$  ( $V_S$ ) for Different Temperatures;  $V_{DD} = 3 V$ 

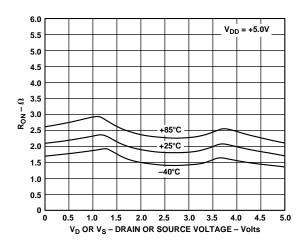


Figure 3. On Resistance as a Function of  $V_D$  ( $V_S$ ) for Different Temperatures;  $V_{DD} = 5 V$ 

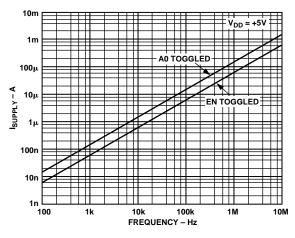


Figure 4. Supply Current vs. Input Switching Frequency

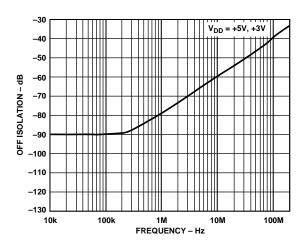


Figure 5. Off Isolation vs. Frequency

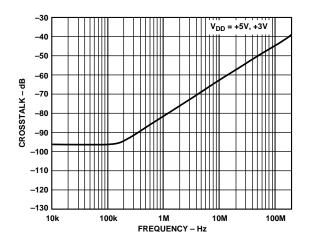


Figure 6. Crosstalk vs. Frequency

## ADG704

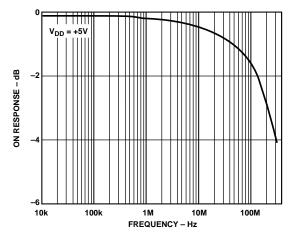


Figure 7. On Response vs. Frequency

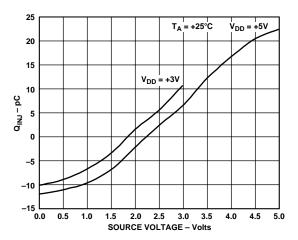


Figure 8. Charge Injection vs. Source Voltage

#### APPLICATIONS

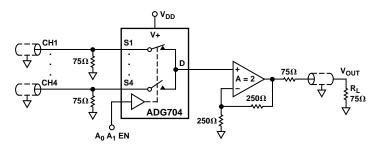
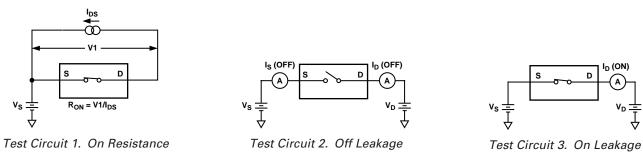
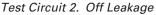


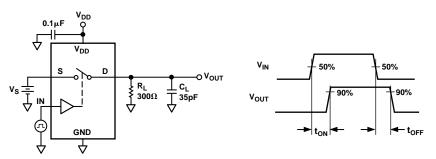
Figure 9. 4-Channel Video Multiplexing

### **Test Circuits**

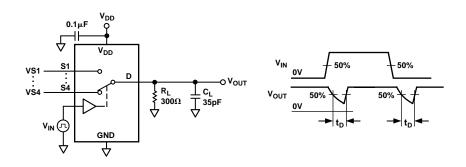


Test Circuit 1. On Resistance

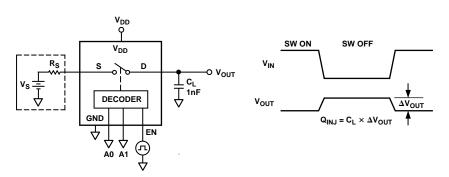




Test Circuit 4. Switching Times

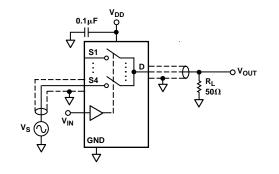


Test Circuit 5. Break-Before-Make Time Delay, t<sub>D</sub>

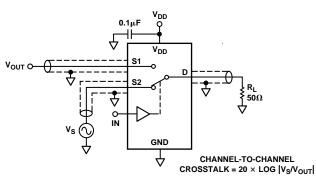


Test Circuit 6. Charge Injection

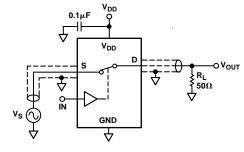
## ADG704



Test Circuit 7. Off Isolation



Test Circuit 8. Channel-to-Channel Crosstalk

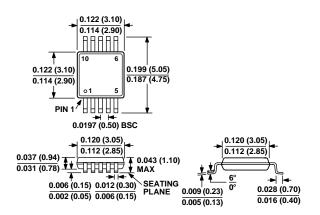


Test Circuit 9. Bandwidth

#### **OUTLINE DIMENSIONS**

Dimensions shown in inches and (mm).

10-Lead μSOIC (RM-10)



# **Mouser Electronics**

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